

IMIP 2025

Kyoto, Japan March 28-31, 2025

2025 7th International Conference on Intelligent Medicine and Image Processing

IMIP 2025 will take place in Suzaku Campus, Ritsumeikan University, Kyoto, Japan during March 28-31, 2025, which is sponsored by Ritsumeikan University and co-sponsored by Tiangong University. As an annual event, IMIP strives to establish a communication platform for esteemed technology leaders, scholars, engineers, scientists, industry experts, and graduate students to exchange ideas and delve into the latest technological developments in Intelligent Medicine and Image Processing and related fields. The conference encompasses keynote speeches, invited talks, oral and poster presentation sessions, video presentations, exhibitions, and other interactive formats, fostering robust communication and information exchange within the field. We are looking forward to seeing you in IMIP 2025!





















Topics:

Smart Healthcare Technology:

Electronic Health Records Cloud Computing and Big Data for Healthcare Collaboration Technologies for Healthcare Medical Robotics Nursing Information

Medical Imaging and Image Processing:

Computed Tomography
Positron Emission Tomography
Magnetic Resonance Imaging
Ultrasonography
Angiography
Medical Image Processing
Medical Imaging Informatics

Optical Imaging in Biomedicine:

Optical Coherence Tomography Biomedical Optics Photonics in Medical Imaging Laser-Based Imaging, Diffuse Optical Imaging Fluorescence Imaging

Please find more topics at https://imip.org/cfp.html

Guest Speakers



Prof. Yen-Wei Chen, Ritsumeikan University, Japan



Prof. Kenji Suzuki, Institute of Science Tokyo, Japan H-index: 63



Prof. Fengchun Tian, Chongqing University, China



Prof. Donghyun Kim, Yonsei University, South Korea SPIE Fellow & H-index: 44



Prof. Paolo Terenziani, University of Eastern Piedmont, Italy



Asst. Prof. Jiaqing Liu, Ritsumeikan University, Japan



Senior lecturer Salmah Binti Karman, University of Malaya, Malaysia

Conference Venue:



Contact:

Suzaku Campus, Ritsumeikan University, Kyoto, Japan Website: https://en.ritsumei.ac.jp/ Address: 1 Nishinokyo-Suzaku-cho Nakaoyo-ku Kyoto 604-852(

Address: 1 Nishinokyo-Suzaku-cho, Nakagyo-ku, Kyoto 604-8520, Japan

Conference Committee:

Conference Chairs

Prof. Yen-Wei Chen, Ritsumeikan University, Japan Prof. Mohd Shafry Mohd Rahim, University Technology Malaysia, Malaysia Prof. Zhitao Xiao, Tiangong University, China

Prof. Hiroshi Fujita, Gifu University, Japan (Honorary)

Prof. Tjokorda Gde Tirta Nindhia, Udayana University, Indonesia

Program Chairs

Prof. Hideaki Haneishi, Chiba University, Japan Prof. Huiyan Jiang, Northeastern University, China Prof. I Wayan Widiada, Udayana University, Indonesia Prof. Tohru Kamiya, Kyushu Institute of Technology, Japan

Prof. Dong Ming, Tianjin University, China

Publication Chairs

Assoc. Prof. Yingchun Guo, Hebei University of Technology, China Dr. Lin Liu, University of Science and Technology Beijing, China

Publication:

Option A: IMIP 2025 SPIE Conference Proceedings, which will be indexed by **Ei Compendex** and **Scopus**, and submitted to be reviewed by CPCI (Web of Science).

Option B: Journal of Image and Graphics (JOIG, ISSN: 2301-3699), which will be included in **Scopus**, Ulrich's Periodicals Directory, Google Scholar, Crossref, IndexCopernicus, etc.

How to attend IMIP 2025:

1. Submit (full paper or abstract):

Option A: https://confsys.iconf.org/submission/imip2025

Option B: icimip@126.com

2. Register as a listener: https://confsys.iconf.org/register/imip2025

3. Join as an Invited Speaker: send your CV to the conference email (icimip@126.com)

Important Dates:

Submission Deadline: Jan. 30, 2025
Notification Date: Feb. 15, 2025
Registration Deadline: Feb. 20, 2025
Conference Date: Mar. 28-31, 2025

Academic Visit (pending):







March 30th (afternoon):

Visits to Renowned Universities tsumeikan University and Kyoto University)

City Visit, Sightseeing at Iconic Kyoto Locations

E-mail: icimip@126.com

onference Secretary: Ms. Ruby He Contact number: +852-3500-0799 (Headquarter)/+86-28-86528465 (Branch Off